SCOPE:

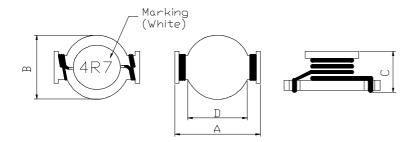
This specification applies to the Pb Free high current type SMD inductors for MSCDB-2206H-SERIES

PRODUCT INDENTIFICATION

MSCDB - 2206H - 4R7 M

- (1)
- 2
- 3 4
- 1 Product Code
- 2 Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 22.3Max. mm
B: 16.2Max. mm
C: 7.40Max. mm
D: 14.5Typ. mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

- (3)-1 Ambient temperature+60°C Max.
- (3)-2 Operate temperature range -40° C $\sim +125^{\circ}$ C (Including self temp. rise)
- (3)-3 Storage temperature range -40° C $\sim +125^{\circ}$ C

TABLE 1

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated D	C Current	Marking
PT/NO.	L(µH)	Tolerance	Frequency	RDC(Ω)Max.	IDC1(A)	IDC2(A)	
MSCDB-2206H-R80	8.0	M,N	100kHz/0.25V	2.76m	35.0	16.0	R80
MSCDB-2206H-1R2	1.2	M,N	100kHz/0.25V	4.20m	30.0	15.0	1R2
MSCDB-2206H-1R8□	1.8	M,N	100kHz/0.25V	5.40m	25.0	13.0	1R8
MSCDB-2206H-2R7□	2.7	M,N	100kHz/0.25V	8.40m	20.0	10.0	2R7
MSCDB-2206H-3R3	3.3	M,N	100kHz/0.25V	9.36m	17.0	9.0	3R3
MSCDB-2206H-4R7□	4.7	M,N	100kHz/0.25V	10.6m	15.0	8.5	4R7
MSCDB-2206H-5R6□	5.6	M,N	100kHz/0.25V	14.9m	14.0	7.8	5R6
MSCDB-2206H-6R8	6.8	M,N	100kHz/0.25V	17.0m	12.0	7.5	6R8
MSCDB-2206H-8R2	8.2	M,N	100kHz/0.25V	18.6m	11.0	7.0	8R2
MSCDB-2206H-100□	10	M,N	100kHz/0.25V	20.6m	10.0	6.5	100
MSCDB-2206H-120	12	L,M	100kHz/0.25V	28.3m	9.5	5.5	120
MSCDB-2206H-150	15	L,M	100kHz/0.25V	33.6m	9.0	5.0	150
MSCDB-2206H-180	18	L,M	100kHz/0.25V	39.6m	8.0	4.6	180
MSCDB-2206H-220	22	L,M	100kHz/0.25V	47.3m	6.5	4.0	220
MSCDB-2206H-270	27	L,M	100kHz/0.25V	52.2m	6.0	3.8	270
MSCDB-2206H-330	33	L,M	100kHz/0.25V	70.1m	5.5	3.4	330
MSCDB-2206H-390	39	K,M	100kHz/0.25V	78.0m	5.2	3.2	390
MSCDB-2206H-470□	47	K,M	100kHz/0.25V	0.109	5.0	2.8	470
MSCDB-2206H-560	56	K,M	100kHz/0.25V	0.116	4.5	2.6	560
MSCDB-2206H-680	68	K,M	100kHz/0.25V	0.134	4.0	2.4	680
MSCDB-2206H-820	82	K,M	100kHz/0.25V	0.173	3.5	2.2	820
MSCDB-2206H-101	100	K,M	100kHz/0.25V	0.202	3.0	2.0	101
MSCDB-2206H-121	120	K,M	100kHz/0.25V	0.230	3.0	1.6	121
MSCDB-2206H-151	150	K,M	100kHz/0.25V	0.250	2.6	1.5	151
MSCDB-2206H-181	180	K,M	100kHz/0.25V	0.300	2.5	1.3	181
MSCDB-2206H-221	220	K,M	100kHz/0.25V	0.380	2.4	1.2	221
MSCDB-2206H-271	270	K,M	100kHz/0.25V	0.470	2.2	1.1	271
MSCDB-2206H-331	330	K,M	100kHz/0.25V	0.560	1.9	1.0	331
MSCDB-2206H-391	390	K,M	100kHz/0.25V	0.680	1.7	0.9	391
MSCDB-2206H-471	470	K,M	100kHz/0.25V	0.850	1.4	0.82	471
MSCDB-2206H-561	560	K,M	100kHz/0.25V	1.00	1.3	0.78	561
MSCDB-2206H-681	680	K,M	100kHz/0.25V	1.10	1.2	0.72	681
MSCDB-2206H-821	820	K,M	100kHz/0.25V	1.40	1.1	0.64	821
MSCDB-2206H-102	1000	K,M	100kHz/0.25V	1.80	1.0	0.56	102

IDC2 : Based on temperature rise ($\triangle T$: 40°C Typ.) Rated DC Current : The less value which is IDC1 or IDC2.



[%] IDC1 : Based on inductance change (△L/Lo : \leq drop 10% Typ.)@ ambient temp. 25°C

(4) RELIABILITY TEST METHOD MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board
		in figure 1 and a load applied unitil the figure in the arrow
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)
	no mechanical	PCB dimension shall the page 7/9
	damage or elec-	F(Pressurization)
	trical damege.	\Box
		R5 45±2 45±2 10 20
		PRESSURE ROD figure-1
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board
		and when a vibration having an amplitude of 1.52mm
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.
	damage.	(A total of 6 hours)
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated
	More than 90%	over the whole of the sample before hard, the sample shall
		then be preheated for about 2 minutes in a temperature of
		130∼150°C and after it has been immersed to a depth 0.5mm
		below for 3±0.2 seconds fully in molten solder M705 with
		a temperature of 245±5℃.
		More than 90% of the electrode sections shall be couered
		with new solder smoothly when the sample is taken out of
		the solder bath.



MECHANICAL

TEST ITEM	SPECIFICATION				
TEST ITEM Resistance to Soldering heat (reflow soldering)	There shall be no damage or problems.	SPECIFICATION Temperature profile of reflow soldering soldering (Peak temperature 260±3°C 10 sec Pre-heating Pre-heating Slow cooling (Stored at room temperature) 2 min 10 sec 2 min. or more			
		The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time.			
		The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.			

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85℃,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20°C ≦±10%.

ENVIROMENT CHARACTERISTICS

TEST ITEM			SPECIFICATION			
High temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmospere with				
storage		a temperatu	a temperature of 85±2℃ and a normal humidity.			
	There shall be	Upon completion of the measurement shall be made after the				
	no mechanical	sample has l	been left in a normal temp	perature and normal		
	damage.	humidity for	1 hour.			
Low temperature	∆L/Lo≦±5%	The sample shall be left for 96±4 hours in an atmosphere with				
storage		a temperature of -25±3℃.				
	There shall be	Upon completion of the test, the measurement shall be made				
	no mechanical	after the san	after the sample has been left in a normal temperature and			
	damage.	normal humi	normal humidity for 1 hour.			
Change of	∆L/Lo≦±5%	The sample	The sample shall be subject to 5 continuos cycles, such as shown			
temperature		in the table 2 below and then it shall be subjected to standard				
	There shall be	atmospheric	atmospheric conditions for 1 hour, after which measurement			
	no other dama-	shall be made.				
	ge of problems					
			table 2			
			Temperature	Duration		
		1	-25±3 ℃	30 min.		
			(Themostat No.1)	00 111111		
		2	Standard	No.4. No.0		
			atmospheric	No.1→No.2		
		3	85±2℃	30 min.		
			(Themostat No.2)	00 mm.		
		4	Standard	No O No 4		
			atmospheric	No.2→No.1		
Moisturo storogo	A L /L a < ±50/	The comple	shall be left for 05±4 become	es in a tomporature of		
Moisture storage	∆L/Lo≦±5%	-	The sample shall be left for 96±4 hours in a temperature of			
	There shall be	40±2℃ and a humidity(RH) of 90~95%.				
		Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and				
	no mechanical		•	mai temperature and		
Test conditions :	damage.	normai numi	dity more than 1 hour.			

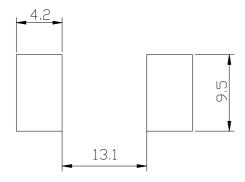


(5) LAND DIMENSION (Ref.)

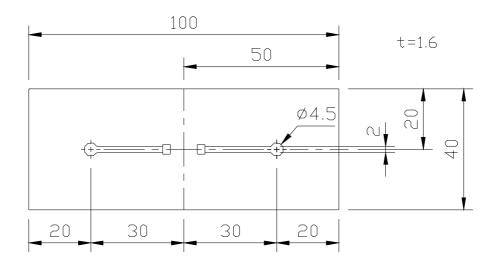
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) unit: mm



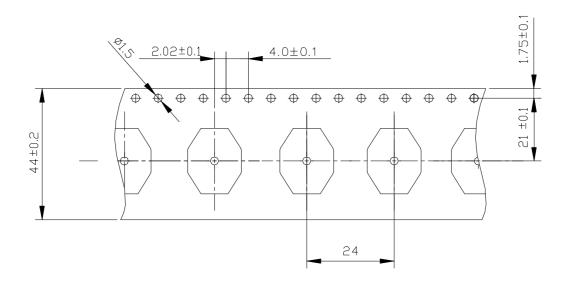
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



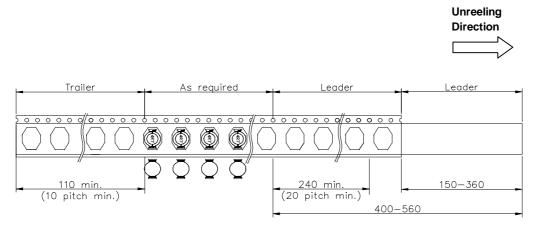


(6) PACKAGING

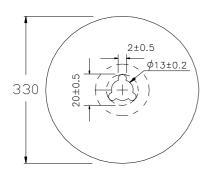
(6)-1 CARRIER TAPE DIMENSIONS (mm)

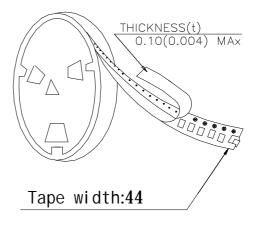


(6)-2 TAPING DIMENSIONS (mm)



(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

300pcs/Reel

The products are packaged so that no damage will be sustained.

